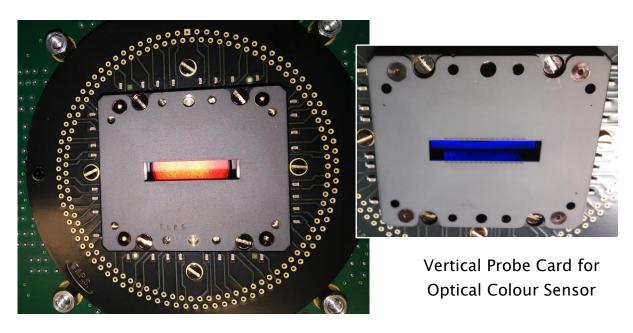




Probe Cards for Optical Sensors (Colour, Automotive LIDAR, X-Ray Imagers...)

State-of-the-art contacting technologies, tailored for excellent contact performance for various chip technologies are combined with sensor stimuli to allow for precise measurements on wafer level for optical sensors.

Contactor geometries amd materials are ranging from vertical probe card technlogies to high performance cantilever technologies, both for laboratory tests and high volume production wafer test.



Cantilever Probe Card for X-ray imaging sensor featuring high-voltage bias supply

